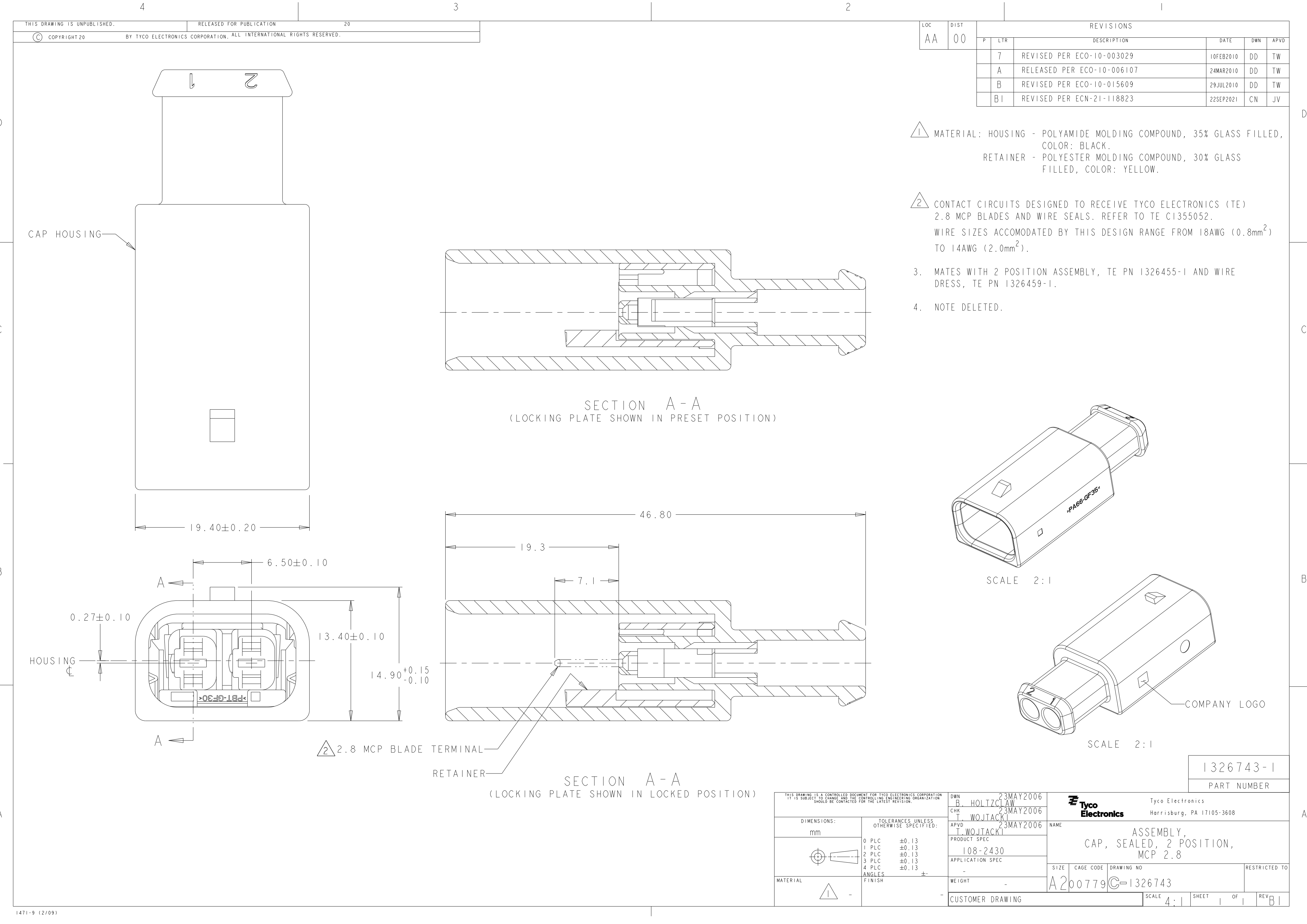




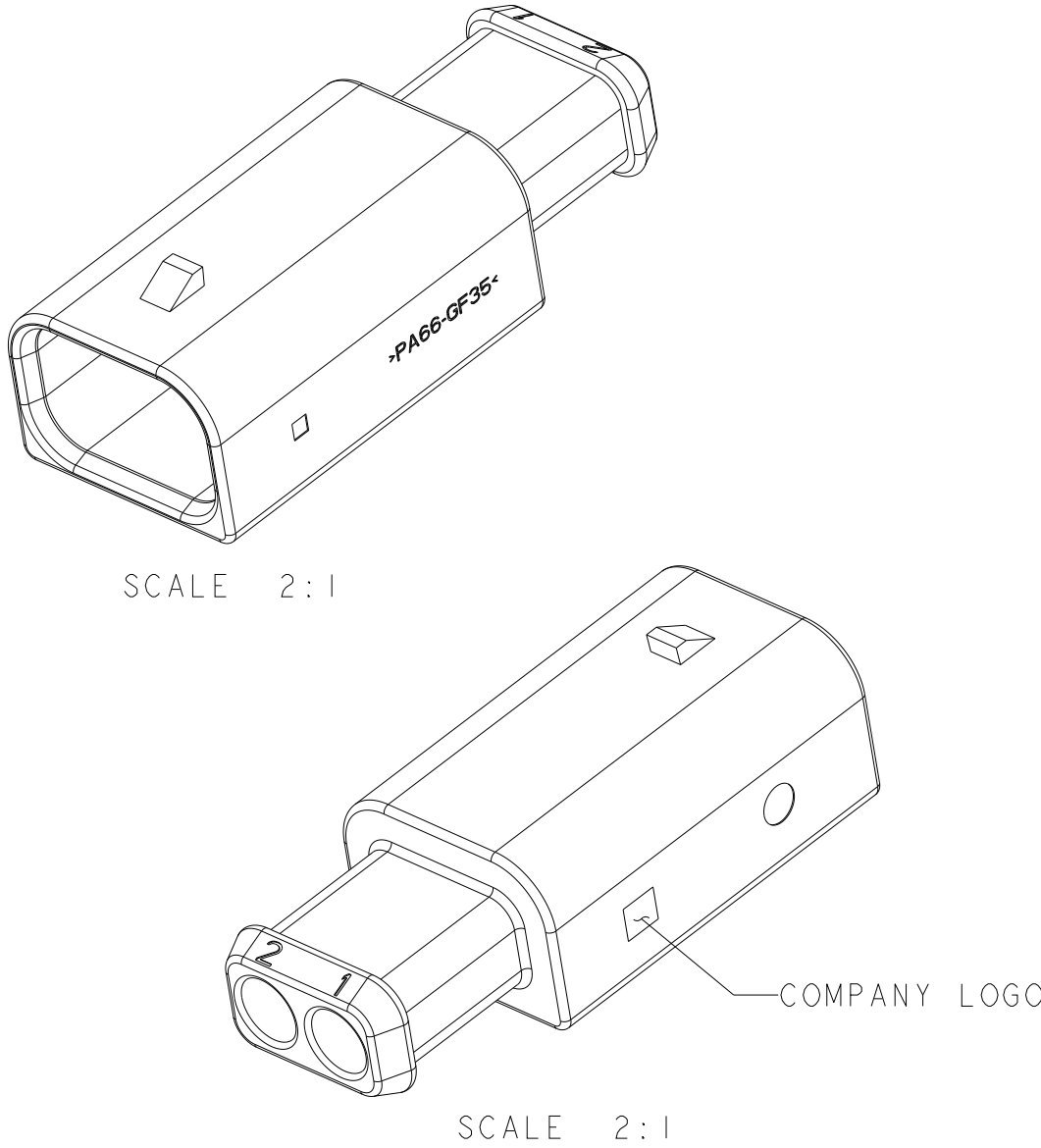
LOC	DIST	REVISIONS					
		P	LTR	DESCRIPTION	DATE	DWN	APVD
AA	00		7	REVISED PER ECO-10-003029	10FEB2010	DD	TW
			A	RELEASED PER ECO-10-006107	24MAR2010	DD	TW
			B	REVISED PER ECO-10-015609	29JUL2010	DD	TW
			BI	REVISED PER ECN-21-118823	22SEP2021	CN	JV

1 MATERIAL: HOUSING - POLYAMIDE MOLDING COMPOUND, 35% GLASS FILLED, COLOR: BLACK.
RETAINER - POLYESTER MOLDING COMPOUND, 30% GLASS FILLED, COLOR: YELLOW.

2 CONTACT CIRCUITS DESIGNED TO RECEIVE TYCO ELECTRONICS (TE) 2.8 MCP BLADES AND WIRE SEALS. REFER TO TE C1355052.
WIRE SIZES ACCOMODATED BY THIS DESIGN RANGE FROM 18AWG (0.8mm²) TO 14AWG (2.0mm²).

3. MATES WITH 2 POSITION ASSEMBLY, TE PN 1326455-1 AND WIRE DRESS, TE PN 1326459-1.

4. NOTE DELETED.



THIS DRAWING IS A CONTROLLED DOCUMENT FOR TYCO ELECTRONICS CORPORATION IT IS SUBJECT TO CHANGE AND THE CONTROLLING ENGINEERING ORGANIZATION SHOULD BE CONTACTED FOR THE LATEST REVISION.		DWN B. HOLTZCLAW 23MAY2006	Tyco Electronics Harrisburg, PA 17105-3608			
DIMENSIONS: mm		CHK T. WOJCIACKI 23MAY2006	NAME ASSEMBLY, CAP, SEALED, 2 POSITION, MCP 2.8			
TOLERANCES UNLESS OTHERWISE SPECIFIED:		APVD T. WOJCIACKI 23MAY2006	SIZE A260779			
0 PLC ±0.13 1 PLC ±0.13 2 PLC ±0.13 3 PLC ±0.13 4 PLC ±0.13 ANGLES ± FINISH -		PRODUCT SPEC 108-2430 APPLICATION SPEC - WEIGHT -	DRAWING NO C-1326743			
MATERIAL 1 -		CUSTOMER DRAWING	SCALE 4:1		SHEET 1 OF 1	REV BI